



Integrated Device Technology, Inc.
6024 Silver Creek Valley Road, San Jose, CA 95138

PRODUCT/PROCESS CHANGE NOTICE (PCN)

PCN #: **TB1908-02** Date: September 10, 2019
 Product Affected: GX72170-DNT/C
 GX72170-DNT
 Date Effective: September 10, 2019

MEANS OF DISTINGUISHING CHANGED DEVICES:
 Product Mark
 Back Mark
 Date Code
 Other PCN Effective Date

Contact: IDT PCN DESK

E-mail: pcndesk@idt.com

DESCRIPTION AND PURPOSE OF CHANGE:

- Die Technology
- Wafer Fabrication Process
- Assembly
- Equipment
- Material
- Test
- Manufacturing Site
- Data Sheet
- Other - MOQ/FOI

This notification is to advise our customers that IDT is changing the Minimum Order Quantity (MOQ) and Frequency Order Increment (FOI) for the select parts from 100 to 400.

Orderable Part	Current MOQ	New MOQ	Current FOI	New FOI
GX72170-DNT/C	100	400	100	400
GX72170-DNT	100	400	100	400